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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

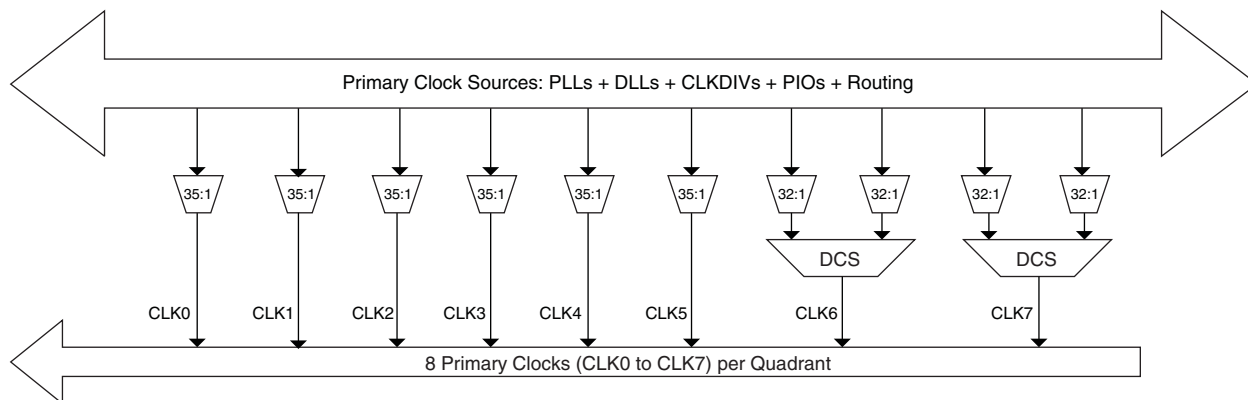
Details

Product Status	Obsolete
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	270
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50se-5f484i

Primary Clock Routing

The clock routing structure in LatticeECP2/M devices consists of a network of eight primary clock lines (CLK0 through CLK7) per quadrant. The primary clocks of each quadrant are generated from muxes located in the center of the device. All the clock sources are connected to these muxes. Figure 2-13 shows the clock routing for one quadrant. Each quadrant mux is identical. If desired, any clock can be routed globally

Figure 2-13. Per Quadrant Primary Clock Selection

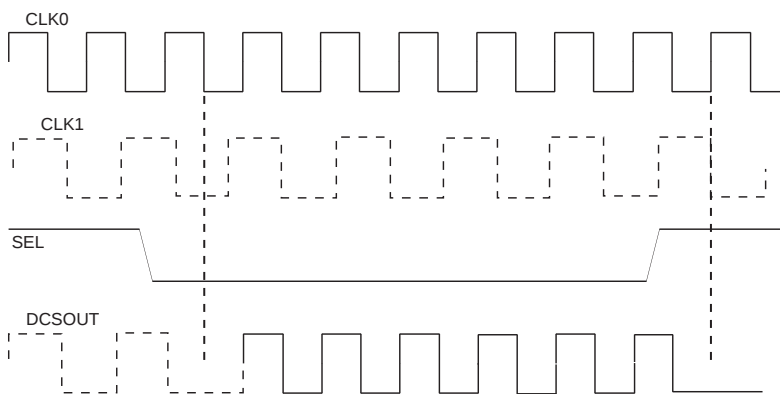


Dynamic Clock Select (DCS)

The DCS is a smart multiplexer function available in the primary clock routing. It switches between two independent input clock sources without any glitches or runt pulses. This is achieved regardless of when the select signal is toggled. There are two DCS blocks per quadrant; in total, there are eight DCS blocks per device. The inputs to the DCS block come from the center muxes. The output of the DCS is connected to primary clocks CLK6 and CLK7 (see Figure 2-13).

Figure 2-14 shows the timing waveforms of the default DCS operating mode. The DCS block can be programmed to other modes. For more information about the DCS, please see the list of additional technical documentation at the end of this data sheet.

Figure 2-14. DCS Waveforms



Secondary Clock/Control Routing

Secondary clocks in the LatticeECP2 devices are region-based resources. The benefit of region-based resources is the relatively low injection delay and skew within the region, as compared to primary clocks. EBR/DSP rows and a special vertical routing channel bound the secondary clock regions. This special vertical routing channel aligns with either the left edge of the center DSP block in the DSP row or the center of the DSP row. Figure 2-15 shows

sysMEM Memory

LatticeECP2/M devices contains a number of sysMEM Embedded Block RAM (EBR). The EBR consists of an 18-Kbit RAM with dedicated input and output registers.

sysMEM Memory Block

The sysMEM block can implement single port, dual port or pseudo dual port memories. Each block can be used in a variety of depths and widths as shown in Table 2-6. FIFOs can be implemented in sysMEM EBR blocks by implementing support logic with PFUs. The EBR block facilitates parity checking by supporting an optional parity bit for each data byte. EBR blocks provide byte-enable support for configurations with 18-bit and 36-bit data widths.

Table 2-6. sysMEM Block Configurations

Memory Mode	Configurations
Single Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36
True Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18
Pseudo Dual Port	16,384 x 1 8,192 x 2 4,096 x 4 2,048 x 9 1,024 x 18 512 x 36

Bus Size Matching

All of the multi-port memory modes support different widths on each of the ports. The RAM bits are mapped LSB word 0 to MSB word 0, LSB word 1 to MSB word 1, and so on. Although the word size and number of words for each port varies, this mapping scheme applies to each port.

RAM Initialization and ROM Operation

If desired, the contents of the RAM can be pre-loaded during device configuration. By preloading the RAM block during the chip configuration cycle and disabling the write controls, the sysMEM block can also be utilized as a ROM.

Memory Cascading

Larger and deeper blocks of RAM can be created using EBR sysMEM Blocks. Typically, the Lattice design tools cascade memory transparently, based on specific design inputs.

Single, Dual and Pseudo-Dual Port Modes

In all the sysMEM RAM modes the input data and address for the ports are registered at the input of the memory array. The output data of the memory is optionally registered at the output.

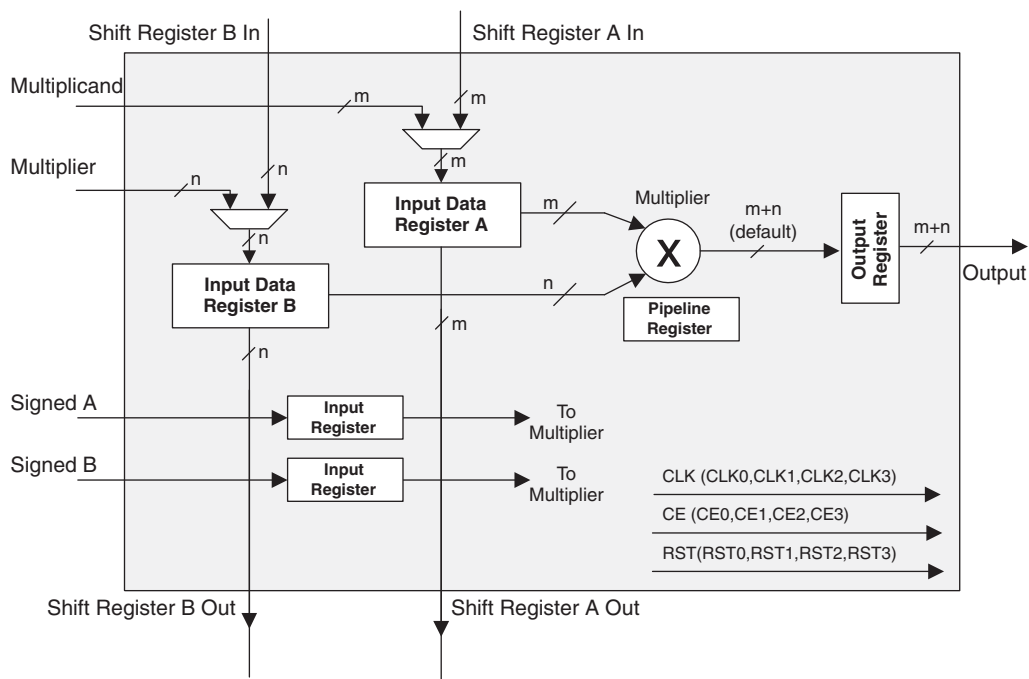
EBR memory supports two forms of write behavior for single port or dual port operation:

1. Normal – Data on the output appears only during a read cycle. During a write cycle, the data (at the current address) does not appear on the output. This mode is supported for all data widths.

MULT sysDSP Element

This multiplier element implements a multiply with no addition or accumulator nodes. The two operands, A and B, are multiplied and the result is available at the output. The user can enable the input/output and pipeline registers. Figure 2-23 shows the MULT sysDSP element.

Figure 2-23. MULT sysDSP Element



IEEE 1149.1-Compliant Boundary Scan Testability

All LatticeECP2/M devices have boundary scan cells that are accessed through an IEEE 1149.1 compliant Test Access Port (TAP). This allows functional testing of the circuit board, on which the device is mounted, through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test data to be captured and shifted out for verification. The test access port consists of dedicated I/Os: TDI, TDO, TCK and TMS. The test access port has its own supply voltage V_{CCJ} and can operate with LVCMOS3.3, 2.5, 1.8, 1.5 and 1.2 standards.

For more details on boundary scan test, please see information regarding additional technical documentation at the end of this data sheet.

Device Configuration

All LatticeECP2/M devices contain two ports that can be used for device configuration. The Test Access Port (TAP), which supports bit-wide configuration, and the sysCONFIG port, support both byte-wide and serial configuration, including the standard SPI Flash interface. The TAP supports both the IEEE Standard 1149.1 Boundary Scan specification and the IEEE Standard 1532 In-System Configuration specification. The sysCONFIG port is a 20-pin interface with six I/Os used as dedicated pins with the remainder used as dual-use pins. See TN1108, [LatticeECP2/M sysCONFIG Usage Guide](#) for more information about using the dual-use pins as general purpose I/Os.

On power-up, the FPGA SRAM is ready to be configured using the selected sysCONFIG port. Once a configuration port is selected, it will remain active throughout that configuration cycle. The IEEE 1149.1 port can be activated any time after power-up by sending the appropriate command through the TAP port.

Enhanced Configuration Option

LatticeECP2/M devices have enhanced configuration features such as: decryption support, TransFR™ I/O and dual boot image support.

1. Decryption Support

LatticeECP2/M devices provide on-chip, One Time Programmable (OTP) non-volatile key storage to support decryption of a 128-bit AES encrypted bitstream, securing designs and deterring design piracy.

2. TransFR (Transparent Field Reconfiguration)

TransFR I/O (TFR) is a unique Lattice technology that allows users to update their logic in the field without interrupting system operation using a single ispVM® command. TransFR I/O allows I/O states to be frozen during device configuration. This allows the device to be field updated with a minimum of system disruption and downtime. See TN1087, [Minimizing System Interruption During Configuration Using TransFR Technology](#), for details.

3. Dual Boot Image Support

Dual boot images are supported for applications requiring reliable remote updates of configuration data for the system FPGA. After the system is running with a basic configuration, a new boot image can be downloaded remotely and stored in a separate location in the configuration storage device. Any time after the update the LatticeECP2/M can be re-booted from this new configuration file. If there is a problem, such as corrupt data during download or incorrect version number with this new boot image, the LatticeECP2/M device can revert back to the original backup configuration and try again. This all can be done without power cycling the system.

For more information about device configuration, please see the list of additional technical documentation at the end of this data sheet.

Soft Error Detect (SED) Support

LatticeECP2/M devices have dedicated logic to perform CRC checks. During configuration, the configuration data bitstream can be checked with the CRC logic block. In addition, the LatticeECP2 device can also be programmed

sysI/O Recommended Operating Conditions

Standard	V _{CCIO}			V _{REF} (V)		
	Min.	Typ.	Max.	Min.	Typ.	Max.
LVC MOS 3.3 ²	3.135	3.3	3.465	—	—	—
LVC MOS 2.5 ²	2.375	2.5	2.625	—	—	—
LVC MOS 1.8	1.71	1.8	1.89	—	—	—
LVC MOS 1.5	1.425	1.5	1.575	—	—	—
LVC MOS 1.2 ²	1.14	1.2	1.26	—	—	—
LVTTL ²	3.135	3.3	3.465	—	—	—
PCI	3.135	3.3	3.465	—	—	—
SSTL18 ² Class I, II	1.71	1.8	1.89	0.833	0.9	0.969
SSTL2 ² Class I, II	2.375	2.5	2.625	1.15	1.25	1.35
SSTL3 ² Class I, II	3.135	3.3	3.465	1.3	1.5	1.7
HSTL ² 15 Class I	1.425	1.5	1.575	0.68	0.75	0.9
HSTL ² 18 Class I, II	1.71	1.8	1.89	0.816	0.9	1.08
LVDS ²	2.375	2.5	2.625	—	—	—
MLVDS25 ¹	2.375	2.5	2.625	—	—	—
LVPECL33 ^{1,2}	3.135	3.3	3.465	—	—	—
BLVDS25 ^{1,2}	2.375	2.5	2.625	—	—	—
RSDS ^{1,2}	2.375	2.5	2.625	—	—	—
SSTL18D_I ² , II ²	1.71	1.8	1.89	—	—	—
SSTL25D_I ² , II ²	2.375	2.5	2.625	—	—	—
SSTL33D_I ² , II ²	3.135	3.3	3.465	—	—	—
HSTL15D_I ²	1.425	1.5	1.575	—	—	—
HSTL18D_I ² , II ²	1.71	1.8	1.89	—	—	—

1. Inputs on chip. Outputs are implemented with the addition of external resistors.

2. Input on this standard does not depend on the value of V_{CCIO}.

sys/I/O Single-Ended DC Electrical Characteristics

Input/Output Standard	V_{IL}		V_{IH}		V_{OL} Max. (V)	V_{OH} Min. (V)	I_{OL}^1 (mA)	I_{OH}^1 (mA)
	Min. (V)	Max. (V)	Min. (V)	Max. (V)				
LVCMOS 3.3	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVTTTL	-0.3	0.8	2.0	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 2.5	-0.3	0.7	1.7	3.6	0.4	$V_{CCIO} - 0.4$	20, 16, 12, 8, 4	-20, -16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.8	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	16, 12, 8, 4	-16, -12, -8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.5	-0.3	$0.35 V_{CCIO}$	$0.65 V_{CCIO}$	3.6	0.4	$V_{CCIO} - 0.4$	8, 4	-8, -4
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
LVCMOS 1.2	-0.3	$0.35 V_{CC}$	$0.65 V_{CC}$	3.6	0.4	$V_{CCIO} - 0.4$	6, 2	-6, -2
					0.2	$V_{CCIO} - 0.2$	0.1	-0.1
PCI	-0.3	$0.3 V_{CCIO}$	$0.5 V_{CCIO}$	3.6	$0.1 V_{CCIO}$	$0.9 V_{CCIO}$	1.5	-0.5
SSTL3 Class I	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.7	$V_{CCIO} - 1.1$	8	-8
SSTL3 Class II	-0.3	$V_{REF} - 0.2$	$V_{REF} + 0.2$	3.6	0.5	$V_{CCIO} - 0.9$	16	-16
SSTL2 Class I	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.54	$V_{CCIO} - 0.62$	7.6	-7.6
							12	-12
SSTL2 Class II	-0.3	$V_{REF} - 0.18$	$V_{REF} + 0.18$	3.6	0.35	$V_{CCIO} - 0.43$	15.2	-15.2
							20	-20
SSTL18 Class I	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.4	$V_{CCIO} - 0.4$	6.7	-6.7
SSTL18 Class II	-0.3	$V_{REF} - 0.125$	$V_{REF} + 0.125$	3.6	0.28	$V_{CCIO} - 0.28$	8	-8
							11	-11
HSTL Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	4	-4
							8	-8
HSTL18 Class I	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	8	-8
							12	-12
HSTL18 Class II	-0.3	$V_{REF} - 0.1$	$V_{REF} + 0.1$	3.6	0.4	$V_{CCIO} - 0.4$	16	-16

1. The average DC current drawn by I/Os between GND connections, or between the last GND in an I/O bank and the end of an I/O bank, as shown in the logic signal connections table shall not exceed $n * 8\text{mA}$, where n is the number of I/Os between bank GND connections or between the last GND in a bank and the end of a bank.

LatticeECP2 Pin Information Summary, LFE2-20 and LFE2-35

Pin Type		LFE2-20				LFE2-35	
		208 PQFP	256 fpBGA	484 fpBGA	672 fpBGA	484 fpBGA	672 fpBGA
Single Ended User I/O		131	193	331	402	331	450
Differential Pair User I/O		62	96	165	200	165	224
Configuration	TAP Pins	5	5	5	5	5	5
	Muxed Pins	14	14	14	14	14	14
	Dedicated Pins (Non TAP)	7	7	7	7	7	7
Non Configuration	Muxed Pins	42	54	60	64	60	68
	Dedicated Pins	3	3	3	3	3	3
VCC		14	7	18	24	16	22
VCCAUX		8	4	16	16	16	16
VCCPLL		0	0	0	0	2	2
VCCIO	Bank0	2	2	4	5	4	5
	Bank1	2	2	4	5	4	5
	Bank2	2	2	4	5	4	5
	Bank3	2	2	4	5	4	5
	Bank4	2	2	4	5	4	5
	Bank5	2	2	4	5	4	5
	Bank6	2	2	4	5	4	5
	Bank7	2	2	4	5	4	5
	Bank8	2	1	2	2	2	2
GND, GND0 to GND7		22	20	60	72	60	72
NC		0	1	8	101	8	102
Single Ended/ Differential I/O Pairs per Bank (including emulated with resistors)	Bank0	18/9	18/9	50/25	67/33	50/25	67/33
	Bank1	18/9	34/17	46/23	52/26	46/23	52/26
	Bank2	11/5	20/10	34/17	36/18	34/17	48/24
	Bank3	11/5	12/6	22/11	32/16	22/11	42/21
	Bank4	19/9	32/16	46/23	50/25	46/23	54/27
	Bank5	18/9	17/8	46/23	68/34	46/23	68/34
	Bank6	18/8	26/13	40/20	48/24	40/20	58/29
	Bank7	12/6	20/10	33/16	35/17	33/16	47/23
	Bank8	6/2	14/7	14/7	14/7	14/7	14/7
True LVDS I/O Pairs per Bank	Bank0 (Top Edge)	0	0	0	0	0	0
	Bank1 (Top Edge)	0	0	0	0	0	0
	Bank2 (Right Edge)	4	5	9	9	9	12
	Bank3 (Right Edge)	3	3	5	8	5	9
	Bank4 (Bottom Edge)	0	0	0	0	0	0
	Bank5 (Bottom Edge)	0	0	0	0	0	0
	Bank6 (Left Edge)	6	7	10	12	10	13
	Bank7 (Left Edge)	5	5	8	8	8	11
	Bank8 (Right Edge)	0	0	0	0	0	0

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 144 TQFP (Cont.)

LFE2-6E/SE					LFE2-12E/12SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
91	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLL_C_IN_A**	C (LVDS)*	
92	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLL_T_IN_A**	T (LVDS)*	
93	RLM0_PLLCAP	3			RLM0_PLLCAP	3			
94	VCC	-			VCC	-			
95	GND	-			GND	-			
96	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLL_C_IN_A**	C (LVDS)*	
97	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLL_T_IN_A**	T (LVDS)*	
98	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C	
99	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T	
100	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*	
101	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*	
102	VCC	-			VCC	-			
103	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C	
104	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T	
105	GND	-			GND	-			
106	VCCIO2	2			VCCIO2	2			
107	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*	
108	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*	
109	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C	
110	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T	
111	PT26B	1		C	PT54B	1		C	
112	PT26A	1		T	PT54A	1		T	
113	PT24B	1		C	PT52B	1		C	
114	PT24A	1		T	PT52A	1		T	
115	PT22B	1		C	PT50B	1		C	
116	PT22A	1		T	PT50A	1		T	
117	VCCIO1	1			VCCIO1	1			
118	PT20B	1		C	PT48B	1		C	
119	PT20A	1		T	PT48A	1		T	
120	GND	-			GND	-			
121	PT18B	1		C	PT44B	1		C	
122	PT18A	1		T	PT44A	1		T	
123	PT16A	1			PT40B	1		C	
124	NC	1			PT40A	1		T	
125	PT14B	1		C	PT34B	1		C	
126	PT14A	1		T	PT34A	1		T	
127	NC	1			NC	1			
128	VCC	-			VCC	-			
129	PT12B	1	PCLKC1_0	C	PT30B	1	PCLKC1_0	C	
130	PT12A	1	PCLKT1_0	T	PT30A	1	PCLKT1_0	T	
131	PT10B	0	PCLKC0_0	C	PT28B	0	PCLKC0_0	C	
132	XRES	0			XRES	0			
133	GND	-			GND	-			
134	PT10A	0	PCLKT0_0	T	PT28A	0	PCLKT0_0	T	
135	VCC	-			VCC	-			

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 208 PQFP (Cont.)

LFE2-12E/SE					LFE2-20E/SE				
Pin Number	Pin/Pad Function	Bank	Dual Function	Differential	Pin/Pad Function	Bank	Dual Function	Differential	
46	PL28B	6	LDQ28	C (LVDS)*	PL42B	6	LDQ42	C (LVDS)*	
47	PL30A	6	LDQ28		PL44A	6	LDQ42		
48	TCK	-			TCK	-			
49	TDI	-			TDI	-			
50	TDO	-			TDO	-			
51	VCCJ	-			VCCJ	-			
52	TMS	-			TMS	-			
53	PB2A	5	VREF2_5/BDQ6	T	PB2A	5	VREF2_5/BDQ6	T	
54	PB2B	5	VREF1_5/BDQ6	C	PB2B	5	VREF1_5/BDQ6	C	
55	VCCIO5	5			VCCIO5	5			
56	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T	
57	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C	
58	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T	
59	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C	
60	GND	-			GND	-			
61	PB12A	5	BDQ15	T	PB12A	5	BDQ15	T	
62	PB12B	5	BDQ15	C	PB12B	5	BDQ15	C	
63	VCCIO5	5			VCCIO5	5			
64	PB16A	5	BDQ15	T	PB16A	5	BDQ15	T	
65	PB16B	5	BDQ15	C	PB16B	5	BDQ15	C	
66	PB18A	5	BDQ15	T	PB18A	5	BDQ15	T	
67	PB18B	5	BDQ15	C	PB18B	5	BDQ15	C	
68	GND	-			GND	-			
69	PB20A	5	BDQ24	T	PB30A	5	BDQ33	T	
70	VCCAUX	-			VCCAUX	-			
71	PB20B	5	BDQ24	C	PB30B	5	BDQ33	C	
72	PB22A	5	BDQ24	T	PB32A	5	BDQ33	T	
73	PB22B	5	BDQ24	C	PB32B	5	BDQ33	C	
74	VCC	-			VCC	-			
75	PB26A	5	PCLKT5_0/BDQ24	T	PB35A	5	PCLKT5_0/BDQ33	T	
76	PB26B	5	PCLKC5_0/BDQ24	C	PB35B	5	PCLKC5_0/BDQ33	C	
77	GND	-			GND	-			
78	PB31A	4	PCLKT4_0/BDQ33	T	PB40A	4	PCLKT4_0/BDQ42	T	
79	PB31B	4	PCLKC4_0/BDQ33	C	PB40B	4	PCLKC4_0/BDQ42	C	
80	VCC	-			VCC	-			
81	GND	-			GND	-			
82	PB34A	4	BDQ33	T	PB42A	4	BDQS42	T	
83	PB34B	4	BDQ33	C	PB42B	4	BDQ42	C	
84	PB36A	4	BDQ33	T	PB44A	4	BDQ42	T	
85	PB36B	4	BDQ33	C	PB44B	4	BDQ42	C	
86	VCCAUX	-			VCCAUX	-			
87	PB40A	4	BDQ42	T	PB50A	4	BDQ51	T	
88	PB40B	4	BDQ42	C	PB50B	4	BDQ51	C	
89	GND	-			GND	-			
90	PB42A	4	BDQS42	T	PB52A	4	BDQ51	T	
91	PB42B	4	BDQ42	C	PB52B	4	BDQ51	C	

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
A5	A5	PT36B	0		C
A3	A3	PT35B	0		C
A4	A4	PT36A	0		T
VCCIO	VCCIO	VCCIO0	0		
B3	B3	PT35A	0		T
A2	A2	PT34B	0		C
C7	C7	PT33B	0		C
B2	B2	PT34A	0		T
D7	D7	PT33A	0		T
D6	D6	PT32B	0		C
GND	GND	GNDIO0	-		
F7	F7	PT31B	0		C
C6	C6	PT32A	0		T
VCCIO	VCCIO	VCCIO0	0		
F6	F6	PT31A	0		T
C4	C4	PT30B	0		C
B4	B4	PT30A	0		T
-	GND	GNDIO0	0		
-	VCC	VCCIO	0		
D5	D5	PT2B	0	VREF2_0	C
E5	E5	PT2A	0	VREF1_0	T
G7	G7	VCC	-		
G9	G9	VCC	-		
H7	H7	VCC	-		
J10	J10	VCC	-		
K10	K10	VCC	-		
K8	K8	VCC	-		
G8	G8	VCCAUX	-		
H10	H10	VCCAUX	-		
J7	J7	VCCAUX	-		
K9	K9	VCCAUX	-		
C5	C5	VCCIO0	0		
E7	E7	VCCIO0	0		
C12	C12	VCCIO1	1		
E10	E10	VCCIO1	1		
E14	E14	VCCIO2	2		
G12	G12	VCCIO2	2		
K12	K12	VCCIO3	3		
M14	M14	VCCIO3	3		
M10	M10	VCCIO4	4		
P12	P12	VCCIO4	4		
M7	M7	VCCIO5	5		

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA

LFE2-50E/SE					LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
D2	PL2A	7	VREF2_7	T (LVDS)*	PL2A	7	VREF2_7	T (LVDS)*	
D1	PL2B	7	VREF1_7	C (LVDS)*	PL2B	7	VREF1_7	C (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
F6	PL5A	7	LDQ8	T	PL18A	7	LDQ21	T	
F5	PL5B	7	LDQ8	C	PL18B	7	LDQ21	C	
VCCIO	VCCIO7	7			VCCIO7	7			
E4	PL6A	7	LDQ8	T (LVDS)*	PL19A	7	LDQ21	T (LVDS)*	
E3	PL6B	7	LDQ8	C (LVDS)*	PL19B	7	LDQ21	C (LVDS)*	
E2	PL7A	7	LDQ8	T	PL20A	7	LDQ21	T	
E1	PL7B	7	LDQ8	C	PL20B	7	LDQ21	C	
GND	GNDIO7	-			GNDIO7	-			
H6	PL8A	7	LDQS8	T (LVDS)*	PL21A	7	LDQS21	T (LVDS)*	
H5	PL8B	7	LDQ8	C (LVDS)*	PL21B	7	LDQ21	C (LVDS)*	
F2	PL9A	7	LDQ8	T	PL22A	7	LDQ21	T	
VCCIO	VCCIO7	7			VCCIO7	7			
F1	PL9B	7	LDQ8	C	PL22B	7	LDQ21	C	
H8	PL10A	7	LDQ8	T (LVDS)*	PL23A	7	LDQ21	T (LVDS)*	
J9	PL10B	7	LDQ8	C (LVDS)*	PL23B	7	LDQ21	C (LVDS)*	
G4	PL11A	7	LDQ8	T	PL24A	7	LDQ21	T	
GND	GNDIO7	-			GNDIO7	-			
G3	PL11B	7	LDQ8	C	PL24B	7	LDQ21	C	
H7	PL12A	7	LDQ16	T (LVDS)*	PL25A	7	LDQ29	T (LVDS)*	
J8	PL12B	7	LDQ16	C (LVDS)*	PL25B	7	LDQ29	C (LVDS)*	
G2	PL13A	7	LDQ16	T	PL26A	7	LDQ29	T	
G1	PL13B	7	LDQ16	C	PL26B	7	LDQ29	C	
H3	PL14A	7	LDQ16	T (LVDS)*	PL27A	7	LDQ29	T (LVDS)*	
VCCIO	VCCIO7	7			VCCIO7	7			
H4	PL14B	7	LDQ16	C (LVDS)*	PL27B	7	LDQ29	C (LVDS)*	
J5	PL15A	7	LDQ16	T	PL28A	7	LDQ29	T	
J4	PL15B	7	LDQ16	C	PL28B	7	LDQ29	C	
J3	PL16A	7	LDQS16	T (LVDS)*	PL29A	7	LDQS29	T (LVDS)*	
GND	GNDIO7	-			GNDIO7	-			
K4	PL16B	7	LDQ16	C (LVDS)*	PL29B	7	LDQ29	C (LVDS)*	
H1	PL17A	7	LDQ16	T	PL30A	7	LDQ29	T	
H2	PL17B	7	LDQ16	C	PL30B	7	LDQ29	C	
VCCIO	VCCIO7	7			VCCIO7	7			
K6	PL18A	7	LDQ16	T (LVDS)*	PL31A	7	LDQ29	T (LVDS)*	
K7	PL18B	7	LDQ16	C (LVDS)*	PL31B	7	LDQ29	C (LVDS)*	
J1	PL19A	7	LDQ16	T	PL32A	7	LDQ29	T	
J2	PL19B	7	LDQ16	C	PL32B	7	LDQ29	C	
GND	GNDIO7	-			GNDIO7	-			
VCCIO	VCCIO7	7			VCCIO7	7			
K3	PL23A	7	LDQ24	T	PL36A	7	LDQ37	T	
K2	PL23B	7	LDQ24	C	PL36B	7	LDQ37	C	
GND	GNDIO7	-			GNDIO7	-			
K1	PL24A	7	LDQS24***	T (LVDS)*	PL37A	7	LDQS37***	T (LVDS)*	

LFE2-50E/SE and LFE2-70E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-50E/SE					LFE2-70E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GND	GNDIO2	-			GNDIO2	-		
L21	PR43B	2	RDQ41	C (LVDS)*	PR56B	2	RDQ54	C (LVDS)*
K22	PR43A	2	RDQ41	T (LVDS)*	PR56A	2	RDQ54	T (LVDS)*
M24	PR42B	2	RDQ41	C	PR55B	2	RDQ54	C
N23	PR42A	2	RDQ41	T	PR55A	2	RDQ54	T
VCCIO	VCCIO2	2			VCCIO2	2		
K26	PR41B	2	RDQ41	C (LVDS)*	PR54B	2	RDQ54	C (LVDS)*
K25	PR41A	2	RDQS41	T (LVDS)*	PR54A	2	RDQS54	T (LVDS)*
M20	PR40B	2	RDQ41	C	PR53B	2	RDQ54	C
GND	GNDIO2	-			GNDIO2	-		
M19	PR40A	2	RDQ41	T	PR53A	2	RDQ54	T
L22	PR39B	2	RDQ41	C (LVDS)*	PR52B	2	RDQ54	C (LVDS)*
M22	PR39A	2	RDQ41	T (LVDS)*	PR52A	2	RDQ54	T (LVDS)*
K21	PR38B	2	RDQ41	C	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2			VCCIO2	2		
M21	PR38A	2	RDQ41	T	PR51A	2	RDQ54	T
K24	PR37B	2	RDQ41	C (LVDS)*	PR50B	2	RDQ54	C (LVDS)*
J24	PR37A	2	RDQ41	T (LVDS)*	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
VCCIO	VCCIO2	2			VCCIO2	2		
L20	VCCPLL	2			NC	-		
GND	GNDIO2	-			GNDIO2	-		
J26	PR26B	2	RUM0_SPLLC_FB_A/RDQ24	C	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
J25	PR26A	2	RUM0_SPLLT_FB_A/RDQ24	T	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
J23	PR25B	2	RUM0_SPLLC_IN_A/RDQ24	C	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
K23	PR25A	2	RUM0_SPLLT_IN_A/RDQ24	T	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
H26	PR24B	2	RDQ24	C (LVDS)*	PR37B	2	RDQ37	C (LVDS)*
H25	PR24A	2	RDQS24***	T (LVDS)*	PR37A	2	RDQS37***	T (LVDS)*
H24	PR23B	2	RDQ24	C	PR36B	2	RDQ37	C
GND	GNDIO2	-			GNDIO2	-		
H23	PR23A	2	RDQ24	T	PR36A	2	RDQ37	T
VCCIO	VCCIO2	2			VCCIO2	2		
G26	PR19B	2	RDQ16	C	PR32B	2	RDQ29	C
GND	GNDIO2	-			GNDIO2	-		
G25	PR19A	2	RDQ16	T	PR32A	2	RDQ29	T
F26	PR18B	2	RDQ16	C (LVDS)*	PR31B	2	RDQ29	C (LVDS)*
F25	PR18A	2	RDQ16	T (LVDS)*	PR31A	2	RDQ29	T (LVDS)*
K20	PR17B	2	RDQ16	C	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2			VCCIO2	2		
L19	PR17A	2	RDQ16	T	PR30A	2	RDQ29	T
E26	PR16B	2	RDQ16	C (LVDS)*	PR29B	2	RDQ29	C (LVDS)*
E25	PR16A	2	RDQS16	T (LVDS)*	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
J22	PR15B	2	RDQ16	C	PR28B	2	RDQ29	C
H22	PR15A	2	RDQ16	T	PR28A	2	RDQ29	T

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
E13	PT28B	1		C	PT46B	1		C	
D12	PT28A	1		T	PT46A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
A9	PT27B	1		C	PT45B	1		C	
A8	PT27A	1		T	PT45A	1		T	
A7	PT26B	1		C	PT44B	1		C	
A6	PT26A	1		T	PT44A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
E12	PT25B	1		C	PT43B	1		C	
F12	PT25A	1		T	PT43A	1		T	
A5	PT24B	1		C	PT42B	1		C	
A4	PT24A	1		T	PT42A	1		T	
GNDIO	GNDIO1	-			GNDIO1	-			
B7	PT23B	1		C	PT41B	1		C	
B8	PT23A	1		T	PT41A	1		T	
G11	PT22B	1		C	PT40B	1		C	
E11	PT22A	1		T	PT40A	1		T	
VCCIO	VCCIO1	1			VCCIO1	1			
D11	PT21B	1	VREF2_1	C	PT39B	1	VREF2_1	C	
D10	PT21A	1	VREF1_1	T	PT39A	1	VREF1_1	T	
F11	PT20A	1	PCLKT1_0	T	PT38A	1	PCLKT1_0	T	
G10	PT20B	1	PCLKC1_0	C	PT38B	1	PCLKC1_0	C	
G9	PT19B	0	PCLKC0_0	C	PT37B	0	PCLKC0_0	C	
GNDIO	GNDIO0	-			GNDIO0	-			
F9	PT19A	0	PCLKT0_0	T	PT37A	0	PCLKT0_0	T	
C9	PT18B	0	VREF2_0	C	PT36B	0	VREF2_0	C	
D9	PT18A	0	VREF1_0	T	PT36A	0	VREF1_0	T	
A2	PT17B	0		C	PT35B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
A3	PT17A	0		T	PT35A	0		T	
B3	PT16B	0		C	PT34B	0		C	
C4	PT16A	0		T	PT34A	0		T	
E10	PT15B	0		C	PT33B	0		C	
F10	PT15A	0		T	PT33A	0		T	
C7	PT14B	0		C	PT32B	0		C	
GNDIO	GNDIO0	-			GNDIO0	-			
B6	PT14A	0		T	PT32A	0		T	
C6	PT13B	0		C	PT31B	0		C	
VCCIO	VCCIO0	0			VCCIO0	0			
C5	PT13A	0		T	PT31A	0		T	
C8	PT12B	0		C	PT30B	0		C	
D8	PT12A	0		T	PT30A	0		T	
E8	PT11B	0		C	PT29B	0		C	
E9	PT11A	0		T	PT29A	0		T	
-	-	-			GNDIO0	-			
-	-	-			VCCIO0	0			
F8	PT10B	0		C	PT10B	0		C	
G8	PT10A	0		T	PT10A	0		T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
Y22	PR60B	3		C	PR81B	3	RDQ82	C	
Y23	PR60A	3		T	PR81A	3	RDQ82	T	
AB26	NC	-			PR80B	3	RDQ82	C (LVDS)*	
AB27	NC	-			PR80A	3	RDQ82	T (LVDS)*	
-	-	-			VCCIO3	3			
Y24	NC	-			PR79B	3	RDQ82	C	
Y25	NC	-			PR79A	3	RDQ82	T	
AA29	NC	-			PR78B	3	RDQ82	C (LVDS)*	
Y28	NC	-			PR78A	3	RDQ82	T (LVDS)*	
Y30	NC	-			PR76B	3	RDQ73	C	
Y29	NC	-			PR76A	3	RDQ73	T	
-	-	-			GNDIO3	-			
-	-	-			-	-			
W22	NC	-			PR75B	3	RDQ73	C (LVDS)*	
V22	NC	-			PR75A	3	RDQ73	T (LVDS)*	
Y27	NC	-			PR74B	3	RDQ73	C	
-	-	-			VCCIO3	3			
Y26	NC	-			PR74A	3	RDQ73	T	
W30	NC	-			PR73B	3	RDQ73	C (LVDS)*	
W29	NC	-			PR73A	3	RDQS73	T (LVDS)*	
-	-	-			GNDIO3	-			
W25	NC	-			PR72B	3	RDQ73	C	
W26	NC	-			PR72A	3	RDQ73	T	
U29	PR59B	3		C (LVDS)*	PR71B	3	RDQ73	C (LVDS)*	
V29	PR59A	3		T (LVDS)*	PR71A	3	RDQ73	T (LVDS)*	
VCCIO	VCCIO3	3			VCCIO3	3			
V30	PR58B	3		C	PR70B	3	RDQ73	C	
U30	PR58A	3		T	PR70A	3	RDQ73	T	
W27	PR57B	3		C (LVDS)*	PR69B	3	RDQ73	C (LVDS)*	
W28	PR57A	3		T (LVDS)*	PR69A	3	RDQ73	T (LVDS)*	
V24	PR55B	3	RDQ52	C	PR67B	3	RDQ64	C	
V25	PR55A	3	RDQ52	T	PR67A	3	RDQ64	T	
GNDIO	GNDIO3	-			GNDIO3	-			
U28	PR54B	3	RDQ52	C (LVDS)*	PR66B	3	RDQ64	C (LVDS)*	
U27	PR54A	3	RDQ52	T (LVDS)*	PR66A	3	RDQ64	T (LVDS)*	
U23	PR53B	3	RDQ52	C	PR65B	3	RDQ64	C	
V23	PR53A	3	RDQ52	T	PR65A	3	RDQ64	T	
VCCIO	VCCIO3	3			VCCIO3	3			
V26	PR52B	3	RDQ52	C (LVDS)*	PR64B	3	RDQ64	C (LVDS)*	
U26	PR52A	3	RDQS52	T (LVDS)*	PR64A	3	RDQS64	T (LVDS)*	
U25	PR51B	3	RDQ52	C	PR63B	3	RDQ64	C	
GNDIO	GNDIO3	-			GNDIO3	-			
U24	PR51A	3	RDQ52	T	PR63A	3	RDQ64	T	
T30	PR50B	3	RDQ52	C (LVDS)*	PR62B	3	RDQ64	C (LVDS)*	
R30	PR50A	3	RDQ52	T (LVDS)*	PR62A	3	RDQ64	T (LVDS)*	
T23	PR49B	3	RDQ52	C	PR61B	3	RDQ64	C	
VCCIO	VCCIO3	3			VCCIO3	3			
T22	PR49A	3	RDQ52	T	PR61A	3	RDQ64	T	

LFE2M50E/SE and LFE2M70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M50E/SE					LFE2M70E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
K13	VCCIO0	0			VCCIO0	0			
D17	VCCIO1	1			VCCIO1	1			
E22	VCCIO1	1			VCCIO1	1			
E25	VCCIO1	1			VCCIO1	1			
F19	VCCIO1	1			VCCIO1	1			
K18	VCCIO1	1			VCCIO1	1			
K19	VCCIO1	1			VCCIO1	1			
F28	VCCIO2	2			VCCIO2	2			
J25	VCCIO2	2			VCCIO2	2			
K28	VCCIO2	2			VCCIO2	2			
M21	VCCIO2	2			VCCIO2	2			
M24	VCCIO2	2			VCCIO2	2			
N21	VCCIO2	2			VCCIO2	2			
N28	VCCIO2	2			VCCIO2	2			
P21	VCCIO2	2			VCCIO2	2			
R25	VCCIO2	2			VCCIO2	2			
AA28	VCCIO3	3			VCCIO3	3			
AB25	VCCIO3	3			VCCIO3	3			
AE28	VCCIO3	3			VCCIO3	3			
T25	VCCIO3	3			VCCIO3	3			
U21	VCCIO3	3			VCCIO3	3			
V21	VCCIO3	3			VCCIO3	3			
V28	VCCIO3	3			VCCIO3	3			
W21	VCCIO3	3			VCCIO3	3			
W24	VCCIO3	3			VCCIO3	3			
AA18	VCCIO4	4			VCCIO4	4			
AA19	VCCIO4	4			VCCIO4	4			
AE19	VCCIO4	4			VCCIO4	4			
AF22	VCCIO4	4			VCCIO4	4			
AG17	VCCIO4	4			VCCIO4	4			
AG25	VCCIO4	4			VCCIO4	4			
AA12	VCCIO5	5			VCCIO5	5			
AA13	VCCIO5	5			VCCIO5	5			
AE12	VCCIO5	5			VCCIO5	5			
AF9	VCCIO5	5			VCCIO5	5			
AG14	VCCIO5	5			VCCIO5	5			
AG6	VCCIO5	5			VCCIO5	5			
AA3	VCCIO6	6			VCCIO6	6			
AB6	VCCIO6	6			VCCIO6	6			
AE3	VCCIO6	6			VCCIO6	6			
T6	VCCIO6	6			VCCIO6	6			
U10	VCCIO6	6			VCCIO6	6			
V10	VCCIO6	6			VCCIO6	6			
V3	VCCIO6	6			VCCIO6	6			
W10	VCCIO6	6			VCCIO6	6			
W7	VCCIO6	6			VCCIO6	6			
F3	VCCIO7	7			VCCIO7	7			
J6	VCCIO7	7			VCCIO7	7			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M23	GND	-		
M8	GND	-		
N14	GND	-		
N15	GND	-		
N16	GND	-		
N17	GND	-		
N27	GND	-		
N4	GND	-		
P11	GND	-		
P13	GND	-		
P14	GND	-		
P15	GND	-		
P16	GND	-		
P17	GND	-		
P18	GND	-		
P20	GND	-		
R10	GND	-		
R11	GND	-		
R13	GND	-		
R14	GND	-		
R15	GND	-		
R16	GND	-		
R17	GND	-		
R18	GND	-		
R20	GND	-		
R21	GND	-		
R24	GND	-		
R7	GND	-		
T10	GND	-		
T11	GND	-		
T13	GND	-		
T14	GND	-		
T15	GND	-		
T16	GND	-		
T17	GND	-		
T18	GND	-		
T20	GND	-		
T21	GND	-		
T24	GND	-		
T7	GND	-		
U11	GND	-		
U13	GND	-		
U14	GND	-		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
U15	GND	-		
U16	GND	-		
U17	GND	-		
U18	GND	-		
U20	GND	-		
V14	GND	-		
V15	GND	-		
V16	GND	-		
V17	GND	-		
V27	GND	-		
V4	GND	-		
W23	GND	-		
W8	GND	-		
Y14	GND	-		
Y15	GND	-		
Y16	GND	-		
Y17	GND	-		
AA26	NC	-		
AB10	NC	-		
AB11	NC	-		
AB12	NC	-		
AB13	NC	-		
AB14	NC	-		
AB15	NC	-		
AB16	NC	-		
AB17	NC	-		
AB19	NC	-		
AB20	NC	-		
AB21	NC	-		
AB9	NC	-		
AC10	NC	-		
AC11	NC	-		
AC21	NC	-		
AC22	NC	-		
AC8	NC	-		
AC9	NC	-		
AD21	NC	-		
AD22	NC	-		
AD4	NC	-		
AD5	NC	-		
AD6	NC	-		
AD7	NC	-		
AD8	NC	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AN29	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13		
AM28	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AL27	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AM29	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AL29	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AL30	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AK30	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AK29	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AM30	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AL31	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AM31	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AN30	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13		
AP30	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T
AL32	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13		
AP31	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C
AN31	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13		
AP32	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C
AM34	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13		
AP33	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T
AN32	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13		
AM32	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C
AN34	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13		
AM33	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T
AN33	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13		
AH28	CFG2	8			CFG2	8		
AD24	CFG1	8			CFG1	8		
AJ29	CFG0	8			CFG0	8		
AF25	PROGRAMN	8			PROGRAMN	8		
AJ28	CCLK	8			CCLK	8		
AE25	INITN	8			INITN	8		
AK31	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AE24	WRITEN***	8			WRITEN***	8		
AJ30	CS1N***	8			CS1N***	8		
AD25	CSN***	8			CSN***	8		
AG29	D0/SPIFASTN***	8			D0/SPIFASTN***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG28	D1***	8			D1***	8		
AG30	D2***	8			D2***	8		
AH29	D3***	8			D3***	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AF26	D4***	8			D4***	8		
AH30	D5***	8			D5***	8		
AE26	D6***	8			D6***	8		
AJ31	D7/SPID0***	8			D7/SPID0***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG27	DI/CSSPI0N***	8			DI/CSSPI0N***	8		
AK32	DOUT/CSN/ CSSPI1N***	8			DOUT/CSN/ CSSPI1N***	8		
AK33	BUSY/SISPI***	8			BUSY/SISPI***	8		

LatticeECP2M Standard Series Devices, Conventional Packaging
Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M20E-5F484C	304	1.2V	-5	fpBGA	484	COM	20
LFE2M20E-6F484C	304	1.2V	-6	fpBGA	484	COM	20
LFE2M20E-7F484C	304	1.2V	-7	fpBGA	484	COM	20
LFE2M20E-5F256C	140	1.2V	-5	fpBGA	256	COM	20
LFE2M20E-6F256C	140	1.2V	-6	fpBGA	256	COM	20
LFE2M20E-7F256C	140	1.2V	-7	fpBGA	256	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M35E-5F672C	410	1.2V	-5	fpBGA	672	COM	35
LFE2M35E-6F672C	410	1.2V	-6	fpBGA	672	COM	35
LFE2M35E-7F672C	410	1.2V	-7	fpBGA	672	COM	35
LFE2M35E-5F484C	303	1.2V	-5	fpBGA	484	COM	35
LFE2M35E-6F484C	303	1.2V	-6	fpBGA	484	COM	35
LFE2M35E-7F484C	303	1.2V	-7	fpBGA	484	COM	35
LFE2M35E-5F256C	140	1.2V	-5	fpBGA	256	COM	35
LFE2M35E-6F256C	140	1.2V	-6	fpBGA	256	COM	35
LFE2M35E-7F256C	140	1.2V	-7	fpBGA	256	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M50E-5F900C	410	1.2V	-5	fpBGA	900	COM	50
LFE2M50E-6F900C	410	1.2V	-6	fpBGA	900	COM	50
LFE2M50E-7F900C	410	1.2V	-7	fpBGA	900	COM	50
LFE2M50E-5F672C	372	1.2V	-5	fpBGA	672	COM	50
LFE2M50E-6F672C	372	1.2V	-6	fpBGA	672	COM	50
LFE2M50E-7F672C	372	1.2V	-7	fpBGA	672	COM	50
LFE2M50E-5F484C	270	1.2V	-5	fpBGA	484	COM	50
LFE2M50E-6F484C	270	1.2V	-6	fpBGA	484	COM	50
LFE2M50E-7F484C	270	1.2V	-7	fpBGA	484	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2M70E-5F1152C	436	1.2V	-5	fpBGA	1152	COM	70
LFE2M70E-6F1152C	436	1.2V	-6	fpBGA	1152	COM	70
LFE2M70E-7F1152C	436	1.2V	-7	fpBGA	1152	COM	70
LFE2M70E-5F900C	416	1.2V	-5	fpBGA	900	COM	70
LFE2M70E-6F900C	416	1.2V	-6	fpBGA	900	COM	70
LFE2M70E-7F900C	416	1.2V	-7	fpBGA	900	COM	70